Mail Stop Assignment Recordation Services Director of the U.S. Patent & Trademark Office P.O. BOX 1450

Atty.	Docket	No.:	2557	-0002	32	/U	S
•				Page			

Alexandria, VA 22313-1450	-2004			
RE 10273	DDD 75			
To the Honorable Commissio	oner of Patents rademarks: ginal documents or copy thereof.			
1. Name of conveying party(ies):	2. Name and address of receiving party(ies)			
Jin-Ho KIM; and	Name: SAMSUNG ELECTRONICS CO., LTD.			
Sung-Hwan YOON	Street Address: 416 Maetan-dong, Yeongtong-gu			
Additional name(s) of conveying party(ies) attached? YES NO Nature of conveyance:	City: Suwon-si, Gyeonggi-do Country: Republic of Korea Postal Code:			
☐ Assignment ☐ Merger ☐ Security Agreement				
☐ Change of Name ☐ Other:	Additional name(s) & address(es) attached? YES NO			
Execution Date: March 16, 2004 and March 16, 2004, respectively	10834187			
4. Application number(s) or patent number(s): If this document is being filed together with a new application, March 16, 2004, respectively	the execution date of the application is: March 16, 2004 and			
A. Patent Application No(s).	B. Patent No.(s).			
Additional numbers atta				
5. Name and address of party to whom correspondence	6. Total No. of applications/patents involved: One (1)			
concerning document should be mailed:	7. Total fee (37 C.F.R. § 3.41): \$40.00			
Name: HARNESS, DICKEY & PIERCE, P.L.C.	⊠ Enclosed			
Street Address: P.O. BOX 8910	Authorized to be charged to deposit account,			
City: RESTON State: VA ZIP: 20195	if no fee attached.			
C 4. TICA	8. Deposit account number: 08-0750			

April 29, 2004 Date

Total number of pages including cover sheet, attachments, and document: Three (3)

DO NOT USE THIS SPACE

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true

Signature

JAC/tsh

04/30/2004 LWONDIM1 00000084 10834187 03 FD/8021 40.00 DP

9. Statement and signature.

copy of the original document.

John A. Castellano/35,094

Name of Person Signing/Reg. No.

04/30/2004 LWOHDIN1 00000089 10834187

Country: USA

03 FC:8021

40.00 DP

(Attach triplicate copy of this page if paying by deposit account)

ASSIGNMENT

Atty. Docket No. 2557-000232/US

WHEREAS, the undersigned, hereinafter referred to collectively as Assignor, has invented:

THIN SEMICONDUCTOR PACKAGE HAVING STACKABLE LEAD FRAME AND METHOD OF MANUFACTURING THE SAME

for which	h Assig	nor is a	about to make or has made United States or International application for
(a)		executed on even date preparatory to filing (each inventor should sign this Assignment on the same day as he/she signs the Declaration and Power of Attorney);
((b)		executed on,; or
((c)		filed on, and assigned Serial No or PCT International Application No;
((d)		U.S. Patent No, issued; and
			AMSUNG ELECTRONICS CO., LTD., a corporation of Korea having a siness at 416 Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do,

Republic of Korea, hereinafter referred to as Assignee, is desirous of acquiring an interest therein:

NOW, THEREFORE, for good and valuable consideration, the receipt and adequacy whereof is hereby acknowledged, Assignor by these presents does sell, assign and transfer unto Assignee and its successors in interest, the full and exclusive right, title and interest in the United States of America and all foreign countries, including the right to claim priority under the laws of the United States, the Paris Convention, and any foreign countries, to the said invention as described in the aforesaid application, said application for patent and all Letters Patent therefor to be held and enjoyed by Assignee to the full end of the term for which said Letters Patent are granted and any extensions thereof as fully and entirely as the same would have been held by Assignor had this assignment and sale not been made, and the right to recover for past infringements of, or liabilities for, any of the rights relating to any of said applications or patents resulting therefrom;

Assignor hereby covenants and agrees to execute all instruments or documents required or requested for the making and prosecution of any applications of any type for patent in the United States and in all foreign countries including, but not limited to, any provisional, continuation, continuation-in-part, divisional, renewal or substitute thereof, and as to letters patent any reissue, re-examination, or extension thereof, and for litigation regarding, or for the purpose of protecting title and to the said invention, the United States application for patent, or Letters Patent therefor, and to testify in support thereof, for the benefit of Assignee without further or other compensation than that above set forth:

Assignor hereby covenants that no assignment, sale or agreement or encumbrance has been or will be entered into which would conflict with this Assignment; and

Assignor hereby requests the Commissioner of Patents and Trademarks to issue said Letters Patent of the United States of America to Assignee, and requests that any official of any country or countries foreign to the United States, whose duty it is to issue or grant patents and applications as aforesaid, to issue said Letters Patent, Utility Model Registration or Inventor's Certificate to Assignee.

The undersigned hereby grant(s) the law firm of Harness, Dickey & Pierce, P.L.C. the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

ASSIGNMENT

JIN-HO KIM

Dated

SUNG-HWAN YOON

2004. 3.16

RECORDED: 04/29/2004

Dated

Page 2 of 2

PATENT REEL: 015282 FRAME: 0874